MITSUBISHI SEMICONDUCTOR <GaAs FET>

MGFC38V5867

5.8~6.75GHz BAND 6W INTERNALLY MATCHED GaAs FET

DESCRIPTION

The MGFC38V5867 device is an internally impedance-matched GaAs power FET especially designed for use in 5.8 ~ 6.75GHz band amplifiers. The hermetically sealed metal-ceramic package guarantees high reliability.

FEATURES

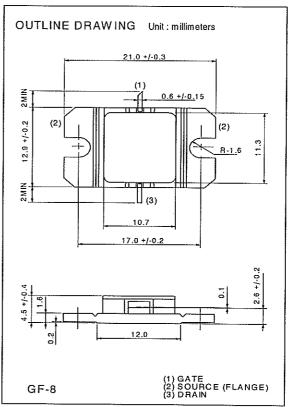
- Class A operation
- Internally matched to 50(ohm) system
- High output power P1dB = 38dBm (TYP.) @ f=5.8 ~ 6.75 GHz
- High power gain GLP = 10 dB (TYP.) @ f=5.8 ~ 6.75 GHz

APPLICATION

VSAT

RECOMMENDED BIAS CONDITIONS

VDS = 10 (V) ID=1.8(A) RG=100 (ohm)



ABSOLUTE MAXIMUM RATINGS (Ta=25deg.C)

Symbol	Parameter	Ratings	Unit	
VGDO	Gate to drain voltage	-15	V	
VGSO	Gate to source voltage	-15	V	
ID	Drain current	5	A	
IGR	Revese gate current	-15	mA	
IGF	Forward gate current	31.5	mA	
PT *1	Total power dissipation	30	W	
Tch	Channel temperature	175	deg.C	
Tstg	Storage temperature	-65 / +175	deg.C	

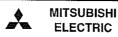
^{*1 :} Tc=25deg.C

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ELECTRICAL CHARACTERISTICS (Ta=25deg.C)

Symbol	Parameter	Test conditions	Limits			Unit
			Min.	Тур.	Max.	
IDSS	Saturated drain current	VDS=3V,VGS=0V	-		5	1
gm	Transconductance	VDS=3V,ID=1.5A	_	2		
VGS(off)	Pinch-off voltage	VDS=3V,ID=15mA			-4.5	V
P1dB	Output power at 1dB gain	***************************************	37.0	38.0	7.0	dBm
GLP	Linear power gain	VDS=10V,ID(RF off)=1.8A. f=5.8 ~ 6.75GHz	8.0	10.0		dB
ID	Drain Current	1 (20) 100 017 017 017		1.7		
P.A.E.	Power added efficiency	1				A
		delta Vf method	- -	32	- E	% deg.C/W

*1 : Channel-case



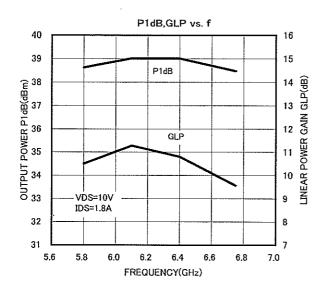
KTTIC http://www.kttic.com

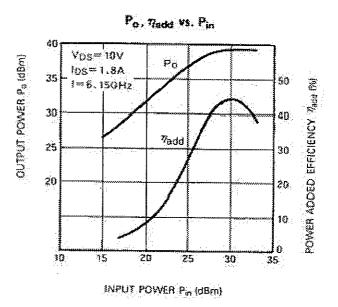
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TYPICAL CHARACTERISTICS (Ta=25deg.C)





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S parameters (Ta=25deg.C, VDS=10(V),IDS=1.8(A))

	S-Parameters (TYP.)							
f (GHz)	S11		S21		S12		S22	
	Magn.	Angle(deg)	Magn.	Angle(deg)	Magn.	Angle(deg)	Magn.	Angle(deg
5.8	0.433	-139	3.314	37	0.036	14	0.449	-68
5.9	0.387	-168	3.402	21	0.041	-13	0.369	-83
6.0	0.354	163	3.493	4	0.047	-36	0.305	-98
6.1	0.339	135	3.549	-14	0.053	-58	0.262	-117
6.2	0.329	109	3.541	-31	0.056	-78	0.224	-139
6.3	0.315	84	3.498	-48	0.062	-96	0.210	-166
6.4	0.297	59	3.416	-65	0.064	-112	0.213	169
6.5	0.276	33	3.328	-82	0.068	-130	0.228	146
6.6	0.259	4	3.243	-99	0.070	-147	0.244	126
6.7	0.262	-30	3.133	-117	0.071	-164	0.261	111
6.8	0.287	-64	3.008	-135	0.071	-179	0.266	97



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